# G3VM-61GR1

**MOS FET Relays** 

# MOS FET Relays with 1-A switching Designed for Switching Minute Signals and Analog Signals.

- Upgraded G3VM-S1 Series.
- Continuous load current of 1 A.

RoHS compliant

# Omaon Omaon Og42

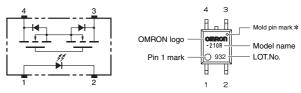
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Note: The actual product is marked differently from the image shown here.

#### ■ Application Examples

- Semiconductor test equipment
- Test & Measurement equipment
- Communication equipment
- Data loggers

#### ■ Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here. \* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

#### **■ List of Models**

Package type	Contact form	Terminals	Load voltage	Model	Minimum package quantity	
rackage type	Contact form		(peak value) *		Number per tube	Number per tape and reel
SOP4	1a (SPST-NO)	Surface-mounting Terminals	60 V	G3VM-61GR1	100	-
SOP4				G3VM-61GR1 (TR)	-	2,500

 $<sup>\</sup>boldsymbol{\ast}$  The AC peak and DC value are given for the load voltage.

#### ■ Absolute Maximum Ratings (Ta = 25°C)

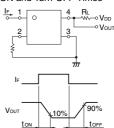
Item		Symbol	Rating	Unit	Measurement conditions
	LED forward current	lF	50	mA	
=	Repetitive peak LED forward current	IFP	1	Α	100 μs pulses, 100 pps
Input	LED forward current reduction rate	∆lf/°C	-0.5	mA/°C	Ta ≥ 25°C
=	LED reverse voltage	VR	5	V	
	Connection temperature	TJ	125	°C	
	Load voltage (AC peak/DC)	Voff	60	V	
b	Continuous load current (AC peak/DC)	lo	1000	mA	
Output	ON current reduction rate	∆lo/°C	-13.3	mA/°C	Ta ≥ 25°C
	Connection temperature	TJ	125	ô	
	lectric strength between (See note 1.)	V <sub>I</sub> -O	1500	Vrms	AC for 1 min
Ambient operating temperature		Ta	-20 to +85	°C	With no icing or condensation
Ambient storage temperature		Tstg	-40 to +125	ô	With no icing or condensation
Soldering temperature		-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

#### **■ Electrical Characteristics** (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
	LED forward voltage	VF	1.0	1.15	1.3	V	IF = 10 mA
Input	Reverse current	IR	-	-	10	μΑ	VR = 5 V
	Capacity between terminals	Ст	-	15	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	1.0	3	mA	Io = 100 mA
Output	Maximum resistance with output ON	Ron	-	0.25	0.7	Ω	If = 5 mA, Io = 1 A
	Current leakage when the relay is open	ILEAK	-	0.2	100	nA	Voff = 60 V
	Capacity between terminals	Coff	-	90	-	pF	V = 0, f = 1 MHz
Capacity between I/O terminals		Cı-o	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		Rı-o	1000	-	-	$M\Omega$	$V_{I-O} = 500 \text{ VDC}, \text{ RoH} \le 60 \%$
Turn-ON time		ton	-	1.4	3.0	ms	IF = 5 mA, RL = 200 $\Omega$ ,
Turn-OFF time		toff	-	0.6	1.0	ms	V <sub>DD</sub> = 20 V (See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



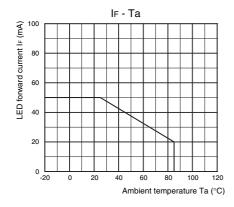
### **■** Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

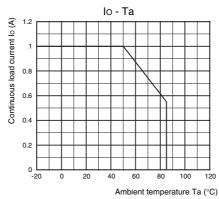
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V <sub>DD</sub>	-	-	48	V
Operating LED forward current	lF	5	10	20	mA
Continuous load current (AC peak/DC)	lo	-	-	1000	mA
Ambient operating temperature	Ta	25	-	60	°C

### **■** Engineering Data

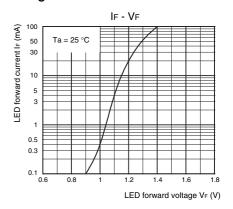
# LED forward current vs. Ambient temperature



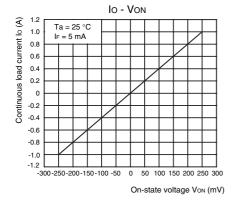
# Continuous load current vs. Ambient temperature



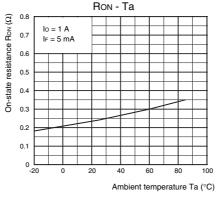
# LED forward current vs. LED forward voltage



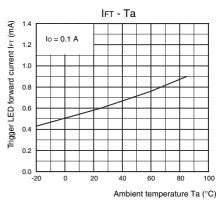
# Continuous load current vs. On-state voltage



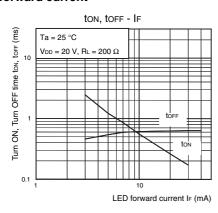
# On-state resistance vs. Ambient temperature



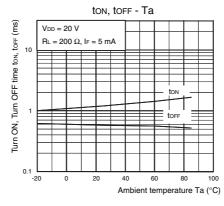
Trigger LED forward current vs. Ambient temperature



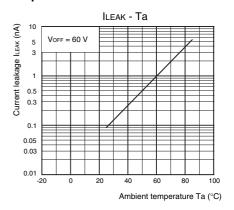
# Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



# Current leakage vs. Ambient temperature



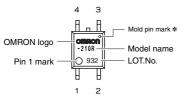
### **■** Safety Precautions

• Refer to "Common Precautions" for all G3VM models.

## **■** Appearance

#### SOP (Small Outline Package)

SOP4



Note: The actual product is marked differently from the image shown here.

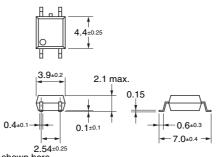
\* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

#### ■ Dimensions (Unit: mm)



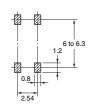
# Surface-mounting Terminals

Weight: 0.1 g



# **Actual Mounting Pad Dimensions**

(Recommended Value, TOP VIEW)



Note: The actual product is marked differently from the image shown here.

Note: Do not use this document to operate the Unit.

Contact: www.omron.com/ecb

Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.

<sup>•</sup> Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.